

IN THE ABSTRACT

Please amend the Abstract on page 66 as follows:

ABSTRACT

A ceramic heater making it possible to make the temperature of a face for heating a silicon wafer even and prevent damage of the silicon wafer. The ceramic heater includes resistance heating elements formed on a surface of a ceramic substrate in a disc form or inside the ceramic substrate. The resistance heating elements are composed of two or more circuits divided in the circumferential direction and are arranged in the outermost periphery of the ceramic substrate. Further, a resistance heating element composed of a different circuit is formed in the inner portion of the resistance heating elements being arranged in the peripheral portion.

REMARKS

Favorable consideration of this application, as presently amended, is respectfully requested.

The present Preliminary Amendment is submitted to place the above-identified application in more proper format under United States practice.

By the present Preliminary Amendment the claims have been amended to no longer recite any improper multiple dependencies. Subject matter of the cancelled multiple dependencies is also now set forth in new dependent Claims 10-15.

The Abstract has also been amended to be in more proper format under United States practice.